

CGHV14250 250 W, 1200 - 1400 MHz, GaN HEMT for L-Band Radar Systems

Cree's CGHV14250 is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically with high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV14250 ideal for 1.2 - 1.4 GHz L-Band radar amplifier applications. transistor could be utilized for band specific applications ranging from UHF through MHz. The package options are ceramic/metal flange and pill package.



Package Type: 440162, 440161 PN: CGHV14250

Typical Performance Over 1.2-1.4 GHz ($T_c = 25^{\circ}c$) of Demonstration Amplifier

Parameter	1.2 GHz	1.25 GHz	1.3 GHz	1.35 GHz	1.4 GHz	Units
Output Power	365	365	350	310	330	W
Gain	18.6	18.6	18.4	17.9	18.2	dB
Drain Efficiency	80	80	77	74	76	%

Note:

Measured in the CGHV14250-AMP1 amplifier circuit, under 500 µs pulse width, 10% duty cycle, P_{IN} = 37 dBm.

Features

- Reference design amplifier 1.2 1.4 GHz Operation
- FET Tuning range UHF through 1800 MHz
- 330 W Typical Output Power
- 18 dB Power Gain
- 77% Typical Drain Efficiency
- <0.3 dB Pulsed Amplitude Droop
- · Internally pre-matched on input, unmatched output



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Absolute Maximum Ratings (not simultaneous)

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V _{DSS}	125	Volts	25°C
Gate-to-Source Voltage	V _{gs}	-10, +2	Volts	25°C
Storage Temperature	T _{stg}	-65, +150	°C	
Operating Junction Temperature	TJ	225	°C	
Maximum Forward Gate Current	I _{GMAX}	42	mA	25°C
Maximum Drain Current ¹	I _{DMAX}	18	А	25°C
Soldering Temperature ²	Τ _s	245	°C	
Screw Torque	τ	40	in-oz	
CW Thermal Resistance, Junction to Case ³	R _{eJC}	0.95	°C/W	P _{DISS} = 167 W, 65°C
Pulsed Thermal Resistance, Junction to Case ³	R _{eJC}	0.57	°C/W	P _{DISS} = 167 W, 500 μsec, 10%, 85°C
Pulsed Thermal Resistance, Junction to Case ⁴	$R_{_{ ext{ ext{ ext{ heta}}JC}}}$	0.63	°C/W	P _{DISS} = 167 W, 500 μsec, 10%, 85°C
Case Operating Temperature ⁵	T _c	-40, +130	°C	P _{DISS} = 167 W, 500 μsec, 10%

Note:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at http://www.cree.com/rf/document-library

³ Measured for the CGHV14250P

⁴ Measured for the CGHV14250F

⁵See also, the Power Dissipation De-rating Curve on Page 5

Electrical Characteristics

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions	
DC Characteristics ¹ ($T_c = 25^{\circ}C$)	DC Characteristics ¹ (T _c = 25 [°] C)						
Gate Threshold Voltage	$V_{\rm GS(th)}$	-3.8	-3.0	-2.3	V _{DC}	$V_{_{DS}}$ = 10 V, I $_{_{D}}$ = 41.8 mA	
Gate Quiescent Voltage	$V_{_{GS(Q)}}$	-	-2.7	-	V _{DC}	$\rm V_{_{DS}}$ = 50 V, $\rm I_{_{D}}$ = 500 mA	
Saturated Drain Current ²	I _{DS}	31.4	37.6	-	А	$V_{_{ m DS}}$ = 6.0 V, $V_{_{ m GS}}$ = 2.0 V	
Drain-Source Breakdown Voltage	V _{BR}	150	-	-	V _{DC}	V _{gs} = -8 V, I _p = 41.8 mA	
RF Characteristics ³ ($T_c = 25^{\circ}C$, $F_0 = 1.3^{\circ}C$	GHz unless oth	erwise noted)					
Output Power	P _{out}	275	330	-	W	$\rm V_{_{DD}}$ = 50 V, $\rm I_{_{DQ}}$ = 500 mA, $\rm P_{_{IN}}$ = 37 dBm	
Drain Efficiency	D _E	63	77	-	%	$\rm V_{_{DD}}$ = 50 V, $\rm I_{_{DQ}}$ = 500 mA, $\rm P_{_{IN}}$ = 37 dBm	
Power Gain	G _P	-	18.2	-	dB	$\rm V_{_{DD}}$ = 50 V, $\rm I_{_{DQ}}$ = 500 mA, $\rm P_{_{IN}}$ = 37 dBm	
Pulsed Amplitude Droop	D	-	-0.3	-	dB	V _{DD} = 50 V, I _{DQ} = 500 mA	
Output Mismatch Stress	VSWR	-	5:1	-	Ψ	No damage at all phase angles, $V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 500 mA, $P_{_{IN}}$ = 37 dBm Pulsed	

Notes:

2

¹ Measured on wafer prior to packaging.

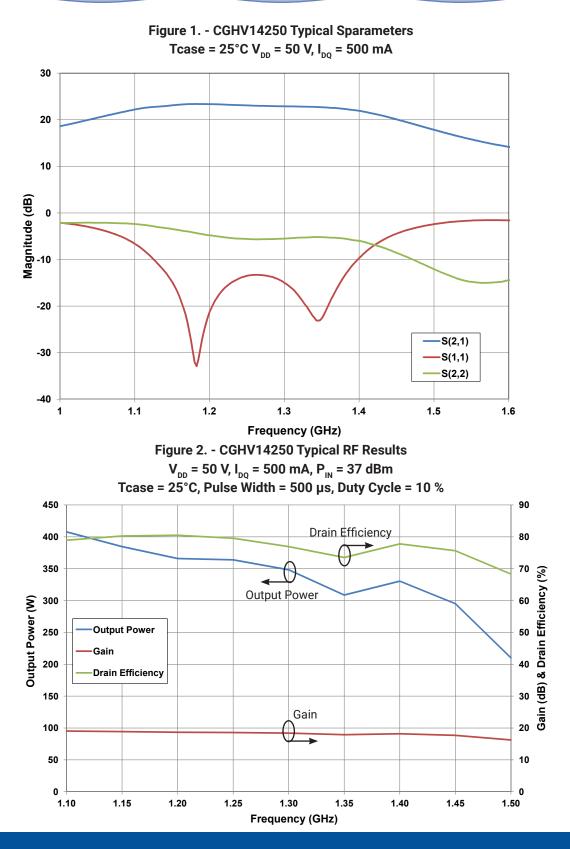
² Scaled from PCM data.

³ Measured in CGHV14250-AMP1. Pulse Width = 500 μ S, Duty Cycle = 10%.

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Typical Performance



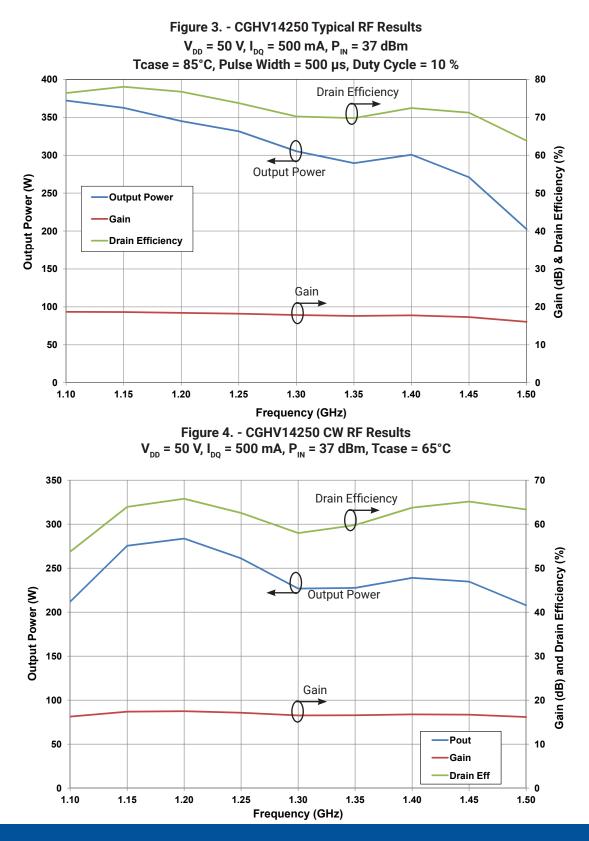
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CGHV14250 Rev 3.0



Typical Performance

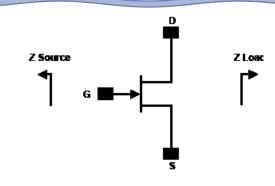


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Source and Load Impedances



Frequency (MHz)	Z Source	Z Load
900	0.6 - j0.3	5.3 + j0.1
1000	0.7 - j0.8	4.3 +j0.8
1100	1.3 - j1.1	3.3 + j0.8
1200	1.8 - j1.1	3.0 + j0.4
1300	2.5 - j0.7	2.5 + j0.4
1400	3.4 - j0.7	2.3 + j0.1
1500	1.8 - j0.9	2.3 + j0

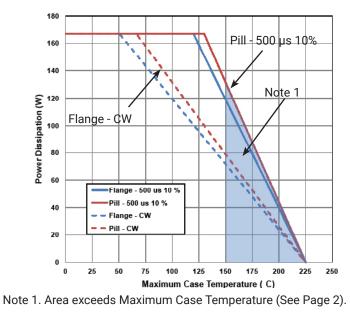
Note 1. V_{DD} = 50 V, I_{DQ} = 500 mA in the 440162 package

Note 2. Optimized for power gain, $\mathsf{P}_{_{\text{SAT}}}$ and Drain Efficiency

Note 3. When using this device at low frequency, series resistors should be used to maintain amplifier stability

CGHV14250F Power Dissipation De-rating Curve



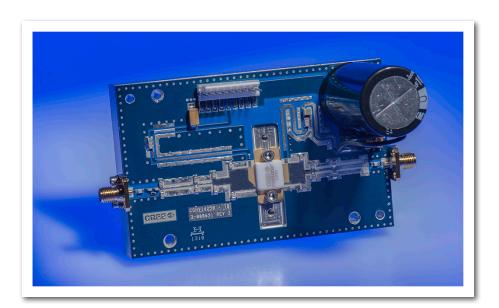


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Designator	Description	Qty
R1	RES, 1/16W, 0603, 1%, 562 OHMS	1
R2	RES, 5.1 OHM, +/-1%, 1/16W, 0603	1
R3	RES, 1/16W, 0603, 1%, 4700 OHMS	1
L1	INDUCTOR, CHIP, 6.8 nH, 0603 SMT	1
C1, C23	CAP, 27pF, +/- 5%, 250V, 0805, ATC 600F	2
C2	CAP, 2.0pF, +/- 0.1pF, 0603, ATC	1
C3, C4	CAP, 0.5pF, +/-0.05pF, 0805, ATC 600F	2
C5,C6	CAP, 1.0pF, +/-0.05 pF, 0805, ATC 600F	2
C7,C8,C9,C10	CAP, 3.0pF, +/-0.1pF, 250V, 0805, ATC 600F	4
C11,C24	CAP, 47pF,+/-5%, 250V, 0805, ATC 600F	2
C12,C25	CAP, 100pF, +/-5%, 250V, 0805, ATC 600F	2
C13,C26	CAP, 33000PF, 0805,100V, X7R	2
C14	CAP 10uF 16V TANTALUM	1
C15,C16,C17,C18	CAP, 3.9pF, +/-0.1pF, 250V, 0805, ATC 600F	4
C19,C20	CAP, 1.2pF, +/-0.05pF, 0805, ATC 600F	2
C27	CAP, 1.0UF, 100V, 10%, X7R, 1210	1
C28	CAP, 3300 UF, +/-20%, 100V, ELECTROLYTIC	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FL	2
J3	HEADER RT>PLZ .1CEN LK 9POS	1
J4	CONNECTOR ; SMB, Straight, JACK,SMD	1
W1	CABLE ,18 AWG, 4.2	1
	PCB, R04350, 0.020 MIL THK, CGHV14250, 1.2-1.4GHZ	1
Q1	CGHV14250	1

CGHV14250-AMP1 Demonstration Amplifier Circuit

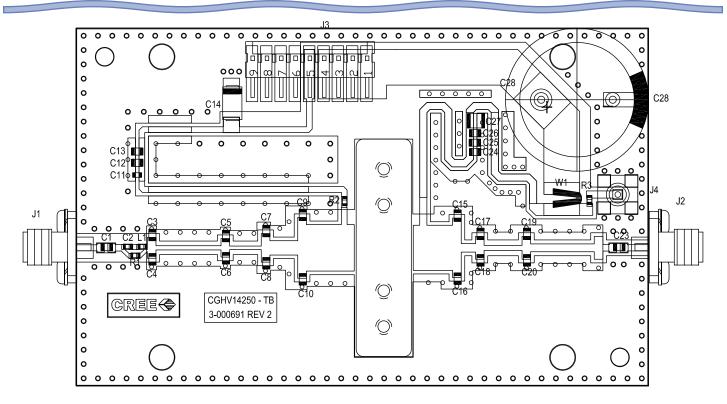


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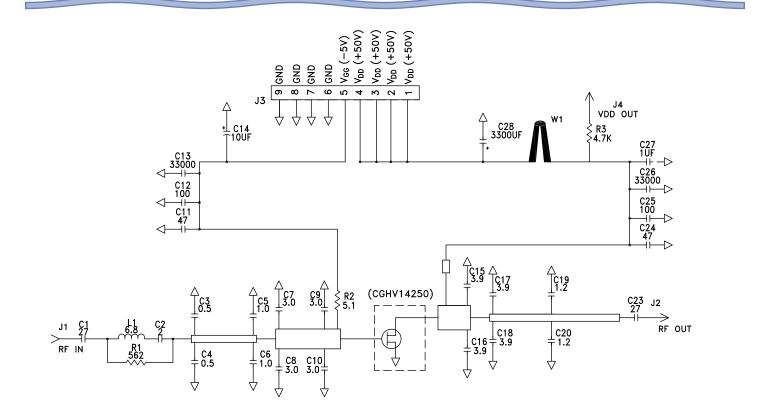
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CGHV14250-AMP1 Demonstration Amplifier Circuit Outline



CGHV14250-AMP1 Demonstration Amplifier Circuit Schematic

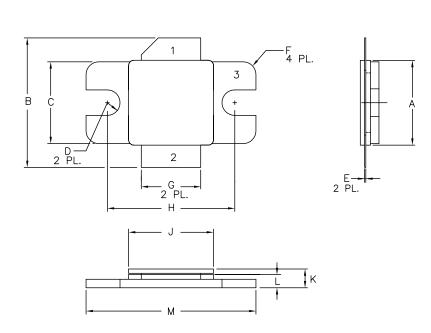


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Product Dimensions CGHV14250F (Package Type - 440162)



NOTES:

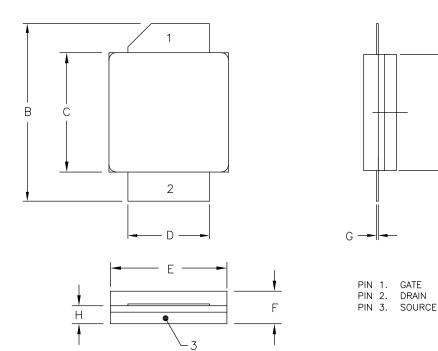
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A
- MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- 4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

	INCHES		MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
A	.395	.405	10.03	10.29
В	.580	.620	14.73	15.75
С	.380	.390	9.65	9.91
D	.055	.065	1.40	1.65
E	.004	.006	0.10	0.15
F	.055	.065	1.40	1.65
G	.275	.285	6.99	7.24
н	.595	.605	15.11	15.37
J	.395	.405	10.03	10.29
к	.129	.149	3.28	3.78
L	.053	.067	1.35	1.70
м	.795	.805	20.19	20.45

GATE DRAIN PIN 1. PIN 2. PIN 3.

SOURCE

Product Dimensions CGHV14250P (Package Type - 440161)



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

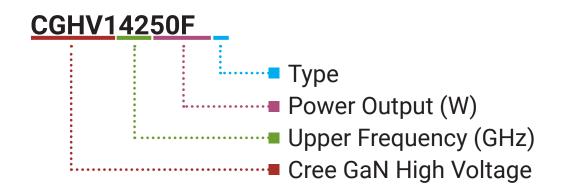
	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
A	.395	.407	10.03	10.34
В	.594	.634	15.09	16.10
С	.395	.407	10.03	10.34
D	.275	.285	6.99	7.24
E	.395	.407	10.03	10.34
F	.129	.149	3.28	3.78
G	.004	.006	0.10	0.15
Н	.057	.067	1.45	1.70

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Part Number System



Parameter	Value	Units
Upper Frequency ¹	1.4	GHz
Power Output	250	W
Туре	F = Flanged P = Package	-

Table 1.

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
Е	4
F	5
G	6
Н	7
J	8
К	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

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Product Ordering Information

Order Number CGHV14250F	Description GaN HEMT	Unit of Measure Each	Image
CGHV14250P	GaN HEMT	Each	CREE CCHUA250P CCCC056385
CGHV14250-TB	Test board without GaN HEMT	Each	
CGHV14250P-AMP1	Test board with GaN HEMT installed	Each	
CGHV14250F-AMP1	Test board with GaN HEMT installed	Each	

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